

Nano fabrication lab Safety training

UNIST UCRF



1. Cleanroom Definition

- 2. Facility resources
- 3. Equipment
- 4. Lab policies
- 5. Wet station
- 6. Emergency measures
- 7. Equipment reservation



🔆 Cleanroom definition

1. What is Cleanroom?

- Special room to manage to lower indoor dusts and airborne particles from prescribed cleanness class and also to control temperature, pressure, humidity and distribution and velocity of air flow within a certain range.
- ullet To gain and maintain cleanliness for the purpose of prevention of environment pollution .
- Cleanliness is the most important in the cleanroom and recently high cleanliness is required in all industries due to the development of industrial technology.

2. Types of Cleanroom

Cleanroom is divided into I.C.R(Industrial Clean Room) and B.C.R(Biological Clean Room) depending on the purpose of the room.

1) Industrial Clean Room(ICR) Applications

- Semiconductor, LCD/PDP manufacturing processes, Computer assembly process
- Optical lens, Film manufacture, Watches, Cameras, Microscopes, Laser device
- Bearing product manufacturing process, Precision

2) Medical Applications of clean room(bio)

- Hospital operating room: sterile hospital room, sterile operating room that require removal of bacteria in the air
- Animals Experiment Laboratory(GLP Good Laboratory Practice): animal experiments or vivo experiments field
- Pharmaceuticals production facilities(G.M.P Good Manufacturing Practice)



* Cleanroom definition

3. Cleanness Class

1) Units of Class

Units of Class are based on the number of dust of 0.5 micron (μ m) in 1 cubic feet(ft³)

Note: 1 cubic feet (ft ³) = horizontal 30.43 cm * vertical 30.43 cm * height 30.43 cm

Unit	Number	Standard	
Unit	number/m ^a	number/ft ³	Stalluaru
CLASS 1	Under 35.3	Under 1	
CLASS 10	Under 353	Under 10	0 Emicrop (um)
CLASS 100	Under 3,530	Under 100	0.5micron (μm)
CLASS 1,000	Under 35,300	Under 1,000	

- 2) Functions of HEPA Filter and ULPA FILTER
 - 1 HEPA filters control to 99.97% of 0.3 (µm) dust
 - 2 ULPA filters control to 99.9997% of 0.3 (µm) dust
- 3) Pressurization : Cleanroom manage the pressure to prevent outside air from entering the clean-room



<Negative>

<Positive>



***** Cleanroom definition

4. Clean room Air conditioning

	Vertical laminar airflow	Horizontal laminar airflow	Turbulent airflow	Mixed airflow	note
Class	1~100	100	1,000~100,000	1,000~100,000	
Cost	high	medium	low	medium	
Layout change	easy	difficult	easy	easy	
Method	S,A	$\begin{array}{c c} S,A & B,A \\ \hline \\ S,A & \rightarrow & \rightarrow & \uparrow \\ \hline \\ S,X & \rightarrow & \rightarrow & \uparrow \\ S,X & \rightarrow & \rightarrow & \downarrow \\ S,X & \rightarrow & \rightarrow & \rightarrow & \downarrow \\ S,X & \rightarrow & \rightarrow & \rightarrow & \rightarrow \\ S,X & \rightarrow & \rightarrow & \rightarrow \\ S,X & \rightarrow & \rightarrow & \rightarrow \\ S,X & \rightarrow \\ S$	S,A S,A S,A R,A R,A R,A	S,A	



< Yellow room >

< White room >



* Cleanroom definition

5. Conditions and management to maintain cleanliness

- 1) Cleanroom cleaning : Conduct once a week with students, administrators and researchers.
- 2) Air conditioner filter replacement cycle.

Division	O.A filter	Pre filter	Medium filter	HEPA filter
Replacement cycle	Frequent	3 months	3 or 6 months	2 years

3) Temperature and humidity management

Division	Period	Temperature	Humidity	Note
Cleanroom	Year round	22°C	55%	24 hours



< UCRF Nanofabrication HVAC Flow Diagram >





- 1. Cleanroom Definition
- 2. Facility resources
- 3. Equipment
- 4. Lab policies
- 5. Wet station
- 6. Emergency measures
- 7. Equipment reservation



✤ Facility resources

1. Management system

- 1) Lab hours
 - Available during working hours only (Monday through Friday, 9am 6pm)
 - During off-hours and weekends is subject to the "long term entrance" rule.
- 2) Common rules (reference the Lab polices)
 - Access application and Equipment reservation
 - Must report process and equipment problems

3) Staff support

	구분	담당자	연락처	비고
	Cleanroom entrance and equipment training	Goh-myeong Bae	4189	
	Process, Imprint, Bonder	Minjae Kim	4064	
П	E-Beam evaporator, Sputter, UHV-CVD, Sam coater, Parylene Coater, PE CVD, LP CVD, Furnace, ALD, Utilities	Hyungil Kim	4065	
Equipment	E-Beam/Photo lithography, Ellipsometer, E-beam evaporator(woosung), Wire bonder, E-beam evaporator, Contact angle, RTP, Surface/optical profiler, probe station, Dicing Saw		4189	
	Wet & Dry Etch process, 4-point probe, Normal SEM, Dicing Saw	Kang-O Kim	4182	
	Cleanroom Tour	Minjae Kim / Hyungil Kim	4064/4065	
	Administrative Q&A or Etc.	Minjae Kim	4064	



★ Facility resources

4) Equipment/Process procedure - <u>http://ucrf.unist.ac.kr</u> (sign up & training application)



- Submit Process request form in the UCRF Homepage
- ref. Cleanroom enterance 1day / 1/3/6 months _ Enterance application form submit
 - Serial Serial Serial Serial Serial Series Se
 - IF Holiday cleanroom safety checklist After professor's signature on it and re-submit us.





2. Fees-I

	장비		이용료		- 로	
구 분	(Model)	분석 항목	단위	내부 (70%)	의부 (100%)	비고
		공정	2ђ.	210,000	300,000	
	E-beam lithography (NB3)	추가요금	0.5 <u>hr</u>	56,000	80,000	. Pattern 의뢰자 제공
	03657	. 기본 FR/PR (AR-P 6200.09, AR 300-71, AR Data consulti baking 및 deve	AR-P 671.0 300-46) ng, Job file	~15		
			0.5 hr	21,000	30,000	
	Photo lithography (MA6#1,#2)	공정	AZ5214, A	실 Chemical 제공 (9X) 24330, A29260, 미요 r, Wet Station, Oven, F	2085, MIF300)	. 개인 재료(PR) <i>사육시,</i> 30분당 1,800원 할인
[0.5ht	17,500	25,000	
	Photo lithography (MDA4005)	공정	AZ5214, A	빈 Chemical 제금 (GXR) Z4330, AZ9260, nLOF2 r, Wet Station, Oven, H	2035, MIF300)	. 개인 재료(PR) <mark>사용</mark> 시 30분당 1,800원 할인
	Nano Imprinter (ANT-6H)	금정	1회 기준 ≤ 3 hy	42,000	60,000	
나도 소자 공정실	Nano Imprinter (ANT-6H)	공정	1회 기준 ≤ 3 <u>hr</u>	42,000	60,000	
	Wet Station (Wet Station)	공정	1회 (1bc) 장기 입실?	21,000	30,000	
			1회	1		
	Deep Si Etcher	공정	≤ 100µm	105,000	150,000	. 100µm 이상 진행시
	(Tegal 200)	추가요금	100µm	35,000	50,000	'별도 협의
[Dielectric RJE (Labstar)	공정	1회 기준	42,000	60,000	. 30분 이상 진행시 별도 협의
[Metal <u>RLE</u> (Labstar)	공정	1회 기준	42,000	60,000	. 30분 이상 진행시 별도 혐의
	Dielectric ICP- <u>RIE</u> (FABstar)	공정	1회 기준	63,000	90,000	. 30분 이상 진행시 별도 협의
	Metal ICP- <u>BJE</u> (FABstar)	공정	1회 기준	63,000	90,000	. 30분 이상 진행시 별도 협의
	PR Asher (V15-G)	공정	1회 기준 ≤ 30min	14,000	20,000	. 30분 이상 진행시 별도 혐의
	SAM coater (AVC-150M)	공정	1호]	42,000	60,000	- Contact angle 측정 무료
	PR Asher (V15-G)	공정	1회 기준 ≤ 30m in	14,000	20,000	. 30분 이상 진행시 별도 협의
	Furnace (KHD-306)	공정	1회 기준 Batch(25장)	210,000	300,000	. 습식 <u>상황망</u> :1μm 기 준 . 건식 <u>상황망</u> :0.3μm 기준



***** Facility resources

2. Fees-II

		장비				이용	료	
구 분	(Model)		분석 항목	단위	내부 (70%)	의부 (100%)	비고	
		DC Spu (SRN-1	itter 20)	공정	1호 (≤ 500nm)	42,000	60,000	
		RF Spu (SRN-1		추가요금	≤ 100nm	7,000	10,000	. 특수 타겠 혐의
				공정	1호 (≤ 30min)	63,000	90,000	· 국구 , (사용자 준비) · 추가요금 기준
	Sputter		20)	추가요금	≤ 30min	63,000	90,000	- 운도: 100ºC/30,000원
			DC	공정	1호 (≤ 500nm)	42,000	60,000	- layer추가 30,000원
		HSC Sputter	~	추가 요금	≤ 100nm	7,000	10,000	30,0002
		(SRN130)	RF	공정	1호 (≤ 30min)	63,000	90,000]
				추가 요금	≤ 30min	63,000	90,000	* 7
		CVD#1,#2 PEH-600		공정	1회	63,000	90,000	. 추가요금 ≤ <u>SiO</u> , 1µm, ≤SisN₄ 0.5µm
		E CVD#3 Star-PECVI	ວ	공정	1호	63,000	90,000	. 추가요금 ≤SiC 0.5µm, ≼SisN⊿ 0.5µm
		LP CVD KVL206		정	1회 기준 Batch(25장)	210,000	300,000	. 추가요금 ≤D-Poly 0.2µm ≤SisN₄ 0.5µm
				공정	1회 기준 ≤ 300nm	63,000 (Single layer)	90,000 (Single layer)	. 6인치 1장 기준 . 재료비 실비 정산
	E-bea	m Evapora MC-4000)	tor	추가 요금	layer추가	31,500	45,000	(Au, Ag, Pd, Pt 등) . 특수 metal 및
					100℃	21,000	30,000	crucible 사용자 준비
	Auto Pa	arylene Coa system URPC-500)	ating	공정	1회 기준	70,000	100,000	
	Atomic	layer depo	sition	공정	1회	75,000	150,000	. 추가요금 100A 이상 추가
	au	cída D100)			121	. 100Å 이상 시 별	도 혐의	중찾시 50시당 40,000원
	Atomic	laver depo	sition			75,000	150,000	. 추가요금 100Å 이상 추가
		premium		공정	1회	. 100Å 이상 시 별도 혐의		중참시 50A당 40,000원
	, L	UC-1		공정	1호	105,000	150,000	
	E-bea	m evapora	tor	공정	1회 기준 ≤ 300nm	63,000 (Single layer)	90,000 (Single layer)	. 6인치(5장), 4인치(13) . 재료비 실비 정산
	Ceme	scal_FC-20	00)	* 107	layer추가	31,500	45,000	(Au, Ag, Pd, Pt 등) . 특수 metal 및
				추가요금	100°C	21,000	30,000	crucible 사용자 준비
		nent Micro Scope Al		측정	1회 기준 ≤ 30min	7,000	10,000	. 장기 읿실자 무료
	Surf	ace Profile (P-6)	er 🛛	축정	1회 기준 ≤ 10min	4,200	6,000	. 장기 읿실자 무료
	Thicknes (ST	s Measure 4000-DLX)	ment	축정	1회 기준 ≤ 10min	4.200	6,000	. 장기 읿실자 무료
		e & Height profiler		축정	1회 기준 ≤ 10min	4.200	6,000	. 장기 읿실자 무료
	4-Point (CM	Probe Sys T-SR2000N	stem I)	측정	1회 기준 ≤ 10min	4,200	6,000	. 장기 읾싦자 무료
								FIDOT IN





2. Fees-III

Contact angle	석 항목	단위	내부	오부	- 비고
measurement			(70%)	(10099)	
	측정	1회 기준 ≤ 10min	4,200	6,000	. 장기 <u>잃실자</u> 무료
Ellipsometer (AR06DM)	측정	1회 기준 ≤ 10min	4,200	6,000	. 추가요금: 신규 물질 reference data . 장기 읾싦자 무료
		추가요금	-	10,000	
Substrate Bonder (SR-6L)	공정	1회	56,000	80,000	
Dicing Saw#1		장 (A공정)	21,000	30,000	.A공정:Non-pattern .B공정:Pattern .추가요금: Dicing
(AR06DM)	공정	장 (8·공정)	28,000	40,000	line 30개 초과 .Glass, Quartz, Si 외
	Γ	추 가요금 (> 30line)	7,000	10,000	기판 혐의
		장 (A공정)	21,000	30,000	.A공정: Non-pattern .B공정: Pattern
Dicing Saw#1	공정	장 (B공정)	28,000	40,000	
		추 가요금 (> 30line)	7,000	10,000	line 30개 소파 .Glass, Quartz, Si 외 기판 협의
		장 (A공정)	21,000	30,000	.A공정: Non-pattern .B공정: Pattern
Dicing Saw#2	공정	장 (B공정)	28,000	40,000	.추가요금: Dicing line 30개 초과
		추 가요금 (> 30line)	7,000	10,000	.Glass, Quartz, Si 외 기판 협의
Normal SEM 미세	구조물 필 분석	시간	28,000	40,000	.추가 요금: Sputter 사용
		추가요금	5,000	10,000	
BTP i	공정	30분	35,000	50,000	
	SMB -	기본료(wyf) >1um	70,000	100,000	.8 [°] , wafer
CMP&Lapping system	ping &	기본료(wf)	42,000	60,000	+
	lishing	>200 µm	14,000	20,000	.6 [°] , wafer
			7,000/d ay	-	
외실료 기	간별		108,000/1M		
12.40.40 21	温泉		215,000/3M		
			380,000/6M		



🜟 시설 이용



FIRST IN CHANGE



4. Bay



Smock Room





Wet Station



Yellow room



E-beam litho. room



White room#1



White room#2



White room#3



Diffusion room



🔆 Facility resources

5. Gowning smock procedure

- smock wear order : wearing mask wearing gloves

 wearing clean garment wearing clean shoes

 smock undressing order : undressing clean shoes undressing
- clean garment undressing clean glove undressing mask



* Wearing mask

- ① Aluminum parts up wearing
- ② Checking whether you press the bridge of the nose.③ Use mask unfolded exactly.





* Wearing cleanroom glove

- ① Wearing clean glove first
- ② Wearing vinyl glove nest
- ③ Make clean gloves to go to the end of neck of clean garment sleeves





- Wear it not to eyebrows visible and put the ends of the mask into the clean cap and moderately tighten the neck strap.
- ② Check the status of the bonding sites not to body inside visible.
- ③ Put the bottom of the cap into the clean garment.

* Wearing clean garment

- Wear private clean garment. If you do not have, wear the blue public clean garment.
- 2 Check zipper bad and wrist elastic state.
- 3 Wear own proper size of clean garment.

* Wearing clean shoes

- ① Wear to the knees.
- ② Check the cleanliness and the tightness of the rubber band.
- ③ Wear own proper size of clean shoes.
- 4 Check zipper status.





6. 방독면 착용

- 1) 방독면 착용 순서
- : 방독면 필터 삽입 방진 마스크 착용 방독면 착용
- 2) 방독면 탈의 순서
- : 방독면 탈착 방진 마스크 탈의 방진 마스크 폐기 및 필터 보관

1

2

✤ 방독면 필터 삽입

1) 알루미늄 부위를 위로 착용
 2) 콧등을 눌러 주었는지 확인
 3) 마스크를 정확하게 펴서 사용

✤ 방독면 착용

 1) 눈썹이 보이지 않게 착용하고, 마스크의 양끝이 방진 모자 안으로 넣어 목 끈을 알맞게 조여서 착용
 2) 속살이 보이지 않게 접착 부위 상태 확인
 3) 방진 모자의 밑 부분이 나오지 않게 방진복 안으로 넣어야 함

❖ 방독면 착용

 1) 개인 방진복을 착용하며, 없을 경우 공용 방진복을 착용
 2) 지퍼불량, 손목부위 고무줄 상태 확인
 3) 자신의 Size에 맞는 방진복을 착용

방진 마스크 착용

 1) 방진장갑을 먼저 착용
 2) 비닐장갑을 착용
 3) 장갑 목 부위가 반드시 방진복
 소매 끝으로 들어가도록 착용
 ※ 케미컬 사용시 라텍스/니트릴
 장갑을 착용



3

4

☆ 방독면 탈착

1) 무릎 까지 착용하였는지 확인
 2) 고무줄 조임 상태 및 청결 상태를 확인
 3) 반드시 자기 Size에 맞는 방진화를 착용
 4) 지퍼 상태가 바른지 확인





- 1. Cleanroom Definition
- 2. Facility resources
- 3. Equipment
- 4. Lab policies
- 5. Wet station
- 6. Emergency measures
- 7. Equipment reservation



💥 Equipment

1. Yellow zone - Lithography

Equipment (Model, Maker)	Specifications	Parameter
E-Beam Lithography (NB3, NBL)	 Theoretical beam size : 2.1nm @ 100 keV, 7nA Line width : < 5nm Deflection : vector scan, 55MHz Address grid resolution : 1nm, 1mm main field Beam voltage : 30~100keV (normally 80KeV) Writing area : 195mm×195mm(8inch) 	 Beam current 0.7, 1.0, 3.5nA Dose depending on PR 671.04 : 8~12 6200.09 : 1.5~2.5 Align mark : 7x10um rectangle Main/Sub field trim dxf CAD File
Mask aligner #1 (MA6, SUSS MicroTec)	 High efficiency & accurate UV exposure system UV lamp : Hg 350 W UV 400 : 350~450 nm (I-, H-, G-line) Gap adjustment accuracy : 1µm Alignment accuracy : 1µm 	• Exposure time • Contact mode • Bake & Develop time
Mask aligner #2 (MDA-400S, MIDAS)	 #1 Methods : top & back side alignment Exposure type : vacuum, low vac., proximity, hard, soft, flood-exposure mode #2 Methods : top side alignment only Microscope magnification : 90x~500x 	• Basic AZ PR provision - AZ5214E, nLoF, 4330, 9260



💥 Equipment

1. Yellow zone - Lithography

Equipment (Mo	del, Maker)	Specifications	Parameter
Nanoimprint lithography (ANT-6H, Elan&KIMM)		 Curing type : UV, thermal, UV & thermal Imprint area : ~ 6 inch Stamp : Quartz, Si, Ni, PDMS, PMMA, etc. Imprint Pressure : ≤ 2 bar (UV), ≤ 60 bar (Thermal) UV System : ~ 50 mw/cm², 2 kW Temperature : RT ~ 250 °C 	• Pressure/ Temp. • Speed
Spin coater & Bake system (SSP200, SVS)		 Spin coater Speed range : Max. 6,000rpm Speed accuracy : Setting RPM ± 1rpm Back side rinse(Back side rinse) : 2-Nozzle position(Acetone) Coater bowl exhaust : 2-hole exhaust Hot-plate Plate flatness : ±10um Temperature control range : ~200°C 	 EBR/ BR Exact time control of Hot plate pin up/down
Spin coater (JSP6D, JD Tech)		 Wafer suitability loading size Chamber size : 300 mm diameter Sample size : piece ~ 6 inch Speed range : Max. 5,000 rpm Vacuum input : - 450mmHg ~ - 750mmHg 	-





2. White zone - Etching

Equipment (M	odel, Maker)	Specifications	Parameter	
Deep RIE (TEGAL 200, TEGAL)		 Loading ~ 6inch Source generator : 5500 W Dual bias generator : LF 300W(pulse), RF 300W E-chuck He cooling system(center/edge) SF₆ / C₄F₈ / O₂ / Ar Bosch process 	 RF Power Gas volume/ ratio Step time(dep vs etching) Chuck temp Pressure Etching time 	
Metal ICP (Fabstar, TTL)		• Load lock / process chamber transfer • Loading : 6inch wafer • ICP source power : 3,000 W (1,000W 내외 사용) • Chuck bias power : 600 W (200W 내외 사용)	 RF Power Gas volume/ ratio Chuck temp 	
Dielectric ICP (Fabstar, TTL)		 Back He cooling (chiller 10 ~ 60°C) Gas Metal ICP : SF₆, CF₄, Cl₂, BCl₃, Ar, O₂, N₂ Dielectric ICP : SF₆, CF₄, CHF₃, Cl₂, BCl₃, Ar, O₂, N₂ 	PressureEtching time	
PR Asher (V15-G, KAMI)		• Ch# size : 250 x 250 x 250 mm • Microwave power generator : 2.45 GHz, 600W • O_2 , Ar , CF ₄ gas control unit : \ge 200 ml/min	 RF Power(Pulse) Gas volume Pressure Ashing time 	





2. White zone - Etching

Equipment	(Model, Maker)	Specifications	Parameter
Metal RIE (Lab star-M, TTL)		 200 mm electrode with water cooled by chiller Loading : piece, 4,6 inch RF generator & auto match network : 600 W, 13.56 MHz solid state 	• RF Power • Gas volume/ ratio • Chuck temp
Dielectric RIE (Lab star-R, TTL)		 Metal RIE MFC BCl₃, Cl₂, SF₆, Ar, O₂ Dielectric RIE MFC CF₄, CHF₃, Ar, O₂ 	PressureEtching time
Wet station (Donghun tech)		• Chemical supply : manual • Chemical temp. : ~ 120 °C • Solvent bath : 4대 Acid bath: 3대 Alkali : 1대	 RCA, SPM Cl'n BOE, KOH Etching PR develop & removing Lift off





3. White zone - Thin-film

Equipment (Model, Maker)		Specifications	Parameter
E-Beam evaporator #1 (FC-2000, Temescal)		 Thickness uniformity : less than ± 5 % (6inch) #1 Temescal 15cc, 6 pockets (Au, Al, Ag, Cr, Ti, Ni, Pt, Pd) Power supply : 6 kW (10kV fix), normal 100mA Substrate heat 300 °C & Rotation Loading : 6inch 5ea, 4inch 13ea #2 Woosung 7cc, 6 pocket (Au, Al, Ag, Cr, Ti, Ni, Pt, Pd, Cu) Power supply : 10 kW (8.5kV beam center) normal 100~200mA Substrate heat 300 °C & Rotation Difference - Loading 6ea vs 1ea (ref, 6inch) source consumption 3 vs 1(ex, 100nm) #2 Cu possible 	 e-beam current substrate heat & rotation sweep Cr, Ti seed Au, Al, Ag for electrode
E-Beam evaporator #2 (WC-4000, Woosung)			
DC Sputter (SRN 120-M, SORONA)		 Substrate size : piece ~ 6 inch Substrate rotation speed : 0 ~ 60 rpm RF pre-cleaning : 300 W / Ar plasma Number of target : 4 different targets Thickness uniformity : less than ± 5% DC Sputter 	• Power
RF Sputter (SRN-120, SORONA)		 Target : Cr, Al, Ag, W, Mo, Co, Substrate heating : 300 °C Power source : 3 kW DC power (actually using under 1kW) RF Sputter Target : ITO, ZnO, SiO₂, Al₂O₃, TiO₂ Substrate heating : 500 °C Power source : 13.56 MHz, 1kW RF power (actually using under 600W) 	 Gas : Ar, O2, N2 (plasma) Temp (normally R.T)





3. White zone - Thin-film

Equipment (Model, Maker)		Specifications	Parameter
PE-CVD #1 (PEH-600, SORONA) PE-CVD #2 (Fabstar-PECVD, TTL)		 Loading size : piece ~ 6 inch Substrate Temperature : ~ 400 °C Power Supply : 600 W, 13.56 MHz RF Generator Thickness uniformity : less than ± 5 % Nitride/Oxide Deposition : 100 Å ~ 2 um #1 SiO₂, Si₃N₄ deposition Process gas : SiH₄, N₂O, NH₃, N₂, CF₄/O₂ #2 Si₃N₄, SiC deposition Process gas : SiH₄, NH₃, CH₄, N₂, SF₆/O₂, He 	• RF power • Pressure • Temp. • Gas volume/ ratio
LP-CVD (KVL206, KSM)		 Wafer size : ~ 6 inch silicon wafer Vertical furnace type(25ea) Thickness uniformity : less than ± 3 % Doped-Poly process gas : SiH₄ : PH₃ =1000 : 80 temp : 530 °C , -dep rate : 35Å/min Nitride process gas : DCS : NH₃ 30 : 100 temp : 785 °C, -dep rate : 25Å/min 	 Gas, Temp., pressure & process time doped poly Sheet resistance 30Ω/sq
UHV-CVD (UHV-CVD, Wooshin)		 vacuum range : 5 x 10 -10mT Heater stage : 1500 °C, 2inch target Gas supply : H2, N2 3 grid LEED, electronics, retraction, fan shutter 	• Vacuum, Temp.





3. White zone - Thin-film

Equipment (Model, Maker)	Specifications	Parameter	
Furnace (Wet & Dry) (KHD-306, KSM)	 Dry & Wet Oxidation process Heater spec (3 zone) : 400(ITO) ~ 1100 °C Wafer size : piece ~ 6 inch, 25ea Thickness uniformity : less than ± 3 % Metal & dielectric film annealing chamber 	 Process Temp. Gas - Dry : O₂ Wet : H₂, O₂ Process time 	
Thermal ALD Image: Cluster ALD	 Substrate size : ~ 8 inch Uniformity : less than ± 2 % HfO₂, TiO₂, Al₂O₃, ZnO Thermal ALD temperature : ~350°C Precursor sources : 3 (heated 2 sources and H₂O source) Cluster ALD 	 Chamber Temp. Source Temp. Source open time Cycle 	
(Atomic premium, CN1)	 temperature : ~450°C Dual process mode : thermal and plasma Dual ch# : metal / non-metal 		
Parylene CoaterImage: Coater Alpha plus(Parylene Coater, Alpha plus)	 Dimer type : c Substrate size : 200 mm Process temperature Furnace (R/T to 1000°C, using 690°C) Vaporizer (R/T to 300 °C, using 175°C) 	• Dimer volume (1.5g/1um, 2hr)	
SAM Coater (AVC-150M, SORONA)	 Contact angle : 5 ° ~ 110 ° (water) Wafer sample size : ≤ 300 mm Precursor usage : 0.1 cc/batch (-> hydrophobic) RF Plasma Surface treatment (-> hydrophilic) 	FOTS volumeSyringe motor control	





4. White zone - Inspection

Equipment (Model, Maker)	Specifications -	
Normal SEM (S-3400N, Hitachi)	 Resolution : 3.0 nm at 30 kV, 10 nm at 3 kV (SE mode) Magnification : x 5 to x 300,000 (continuous) Accelerate voltage : 0.3 to 30 kV (0.1 kV/step) Traverse : X axis 0 ~ 100 mm, Y axis 0 ~ 50 mm 	
Inspection microscope#1 (DM4000M, Leica)	 Magnification(Objective lens) : 2.5x, 5x, 10x, 20x, 50x, 100x, Magnification(Ocular) : 10x 6-position nosepiece(M32), 4-position turret for filer cubes 	
Inspection microscope#2 (Axio scope A1, CarlZeiss)	 Contrast methods RL : BF, DF, Pol, ICR, Fluo CCD : 1/2 inch, 211 mil-pixel CCD image sensor Frame rate : 7.5 F/S & 30 F/S (Optional) Electronic shutter : auto/manual/off, 1/15~ 1/5000 	
Ellipsometer (Elli-SE-UaM8, Elipso Technology)	• Wavelength range : 240 nm ~ 1000 nm (CCD Type) • Beam spot size : \geq 1.5 mm • Measuring constants Film thickness, n, k vs λ • Thickness range : sub A ~ 10 μ • Number of layers Up to 10	





4. White zone - Inspection

Equipment (Model, Maker)		Specifications	-
Thin film measurement (ST4000-DLX, K-MAC)		 Detector : used wavelength range is 400 ~ 800 nm Stage size : 300 mm x 300 mm (12 inch wafer) Lens : m5x, m10x, m50x Reflection probe : choose wavelength (300~800nm) Thickness measurement range : 100 Å ~ 50 μm 	
Surface Profiler (P-6, KLA Tencor)		 Single 2D & 3D scanning profiler 150mm diameter sample stage Automatic step detection and multiple cursor Stylus force : adjustable between 1 ~ 15 mg L-stylus : 2 um radius 60 degree 	
4-Point probe (CMT-SR2000N, AIT)		 Measurement range : Ω, Ω/sq, Ω/cm Current source : 10 nA ~ 100 mA Voltage : 0 ~ 2,000 mV Substrate size(mm) : ~200(wafer) 140×140(square) Data analysis : data map, contour & 3D mapping 	
Contact angle (Phoenix 300, SEO)	e State	 Static / dynamic contact angles Advancing and receding contact angle by captive method Sequence image captures by time basis & dynamic movies Sessile drop/ pendent drop, surface tension 	



💥 Equipment

4. White zone – Inspection & Package

Equipment (Model, Maker)		Specifications	-
Substrate sawing machine (AR06DM, Aaron)		 Substrate size : ~ 6 inch Cutting materials : silicon, glass, quartz & GaAs X-axis (chuck table horizontal movement) Work-piece width setting range : 0.01 ~ 160 mm Cut speed : 0.05 ~10 mm/s or more 	
Substrate bonder (SB-6L, SUSS MicroTec)		 Wafer size : 6" semi standard wafer Pressure regulation accuracy : ± 2 % Maximum temperature : 500 °C (uniformity ± 3 %) Maximum bond force : 8 kN Bond voltage and current (Anodic optional) Maximum voltage : 2,000 V ± polarity Maximum current : 60 mA 	





- 1. Cleanroom Definition
- 2. Facility resources
- 3. Equipment
- 4. Lab policies
- 5. Wet station
- 6. Emergency measures
- 7. Equipment reservation





1. Penalty imposed

[Attached Table 1]

Penalty Points System in UNFC(Cleanroom)

1. Criteria for penalty points.

① A user shall be fined the penalty points in the event that any inappropriate behavior falls under the following. Each penalty item may be counted multiple times. (The expiration of penalty points is 1 year from the date of imposition.)

Case description.		
	A person causes the leakage of a harmful substance such as toxic gases or toxic substances $\ensuremath{\scriptscriptstyle \mathrm{o}}$	10.,
	A person causes fires and accidents.	10.,
	The act of intentionally damaging the equipment.	10.,
	Not notifying the equipment manager when the amount of waste tank storage is more than 1/2 $_{\rm o}$	10.,
Class A Violation.	Not wearing safety equipment (goggles, gas mask, apron, protective gloves, face mask, etc.) when using the wet station or working related to waste tank treatment.	10.,
	Incorrect classification of waste liquid	10.,
	Arbitrarily changing the chemical bath designated for each type (acid, organic, alkali) $\ensuremath{\scriptscriptstyle a}$	10.,
	Operating electricity, gas, firefighting, and other utilities without prior consultation with the equipment manager.	10.,
	Other acts that may damage the safety of others.	10.,
	Equipment is used without reserving it, or equipment is used in excess of the reservation time without permission.	5.,
	A person accesses UNFC using someone else's pass.	5.,
	Use of equipment by making a reservation(login) in someone else's identity,	5.,
	Excessive use of equipment without prior consultation.	5.,
Class B Violation	A person uses or steals the personal items (consumables, equipment, and materials for processes) of another person without prior consent.	5.,
	Use of chemicals not approved by the equipment manager in the cleanroom (including non-submission of application form for importing chemical).	5.,
	A person causes accidents or neglects it after using a chemical substance $\!\!\!\!\!\!\!\!\!$	5.
	A person leaves a seat without leaving a note containing information such as chemical information in use, expected use time, affiliation, name, and contact information during the wet station experiment.	5.,

	Other acts that may endanger safety, damage equipment, or violate \ensuremath{UNFC} rules .	5.,				
	The act of not inputting the usage record or inputting false records after the use of the equipment, \ensuremath{a}	3.,	1			
	Violation of how to wear dust-proof clothing and acts that affect cleanliness (make-up, etc.).					
	A person uses items that are not permitted in the cleanroom.	3.,]			
	A person uses hot plates and chemicals other than the specified hood $\ensuremath{\scriptscriptstyle n}$	3.,				
Class C	A person neglects replaced equipment parts, used process consumables, specimens, etc. for a long time.	3.,]			
Violation.	A person helps another person who has not completed safety training to access UNFC without the consent of the equipment manager $\ _{\rm o}$	3.,				
	A person leaves chemical substances in an unspecified place.	3.				
	A person violates the rules by bringing the prohibited goods or equipment (except for experimental purposes such as laptops and iPads) in.					
	A person runs, leans on equipment, or sits on the floor in the cleanroom.	3.,				
	An action may be judged to require sanctions by damaging the laboratory safety of the cleanroom and another person's equipment use.	3.,	1			

.

2. Actions taken after subjecting penalty points.

- If the cumulative penalty points exceed a certain criterion, the action corresponding with the table below will be taken.
- ② When a user violates the rule, an official letter from UCRF is sent to the department or institution(in case of the user outside) of the violator. The content will be posted on the cleanroom bulletin board.

Туре	Penalty points	Action	
Total penalty points awarded to the individual.	10 points or more.	The user is prohibited from using the equipment for 1 month	
	20 points or more.	The user is prohibited from using the equipment for 3 months. (Access to UNFC of the user is blocked for 1 month in case of damage to the environment of UNFC)	
	30 points or more.	The user is prohibited from accessing UNFC for 3 months	
Total penalty points awarded to students affiliated	40 points or more.	The members of the laboratory are prohibited from using the equipment for 1 month.	
with the same laboratory.	50 points or more.	The members of the laboratory are prohibited from accessing UNFC for 1 month.	





2. Common rules

Common rules

- Finite the cleanroom only after safety training finished (If you do not qualify, contact your administrator).
- ☞ Regular weekday operating hours are 09:00 to 18:00.
- Imese When using the cleanroom after the regular operating hours, two or more people should use cleanroom together.
- Clean Room entrant should comply with the following.
 - Only use dust-free paper and a ballpoint pen (prohibition on use pencil or water-based pen)
 - Must remove the pollutants of take-in items.
 - Items not related to the purpose of the process are restricted. (need administrator approval if you want to carry in)
 - Leaning on the equipment, running (except emergency), and sitting on the table and floor are prohibited.
 - Eating, chewing and wearing make up are prohibited.
- $\ensuremath{\bowtie}$ Aware emergency evacuation and fire extinguisher location.
- ${\scriptstyle\bowtie}$ Be sure to wear the proper protective gear before the experiments.
- ☞ Check over the equipment/chemical before/after use. If there is any problem, report to administrator quickly.

If you leave the room inevitably during experiment, take safety measures and post the experimental details to communicate with others.

 $rac{1}{2}$ Last person who leaves the room should power off the electrical appliances and tidy up.





3. Facility & Equipment

Facility & Equipment

- ☞ Do not put a flammable / combustible materials around the machine.
- ☞ Unavailable equipment should be locked and you have to mark a fault.
- $\ensuremath{\bowtie}$ Be well-informed how to use and cautions when to use machines.
- ☞ During the experiment, wear a suitable protective gear.

Especially during the work of fugitive dust or debris, MUST wear a safety glasses and face shield.

- ☞ Be sure to stop the operation and lock the machine before you clean, inspect, or repair the machines.
- Some when you shut down the operation of the machine, shut off the operating switch and the power switch.

To prevent leakage, check the coolant, supply/drainage valve and piping that are connected to the equipment or machine frequently.





4. Electronics

Electronics

- The Do not expose all of the contact portion of the electrical equipment such as wiring, wet money or thing prohibited the contact of electrical equipment.
- IF When unplugging, do not pull on the wires, hold and pull the plug.
- ☞ Use suitable electrical facilities cord or wiring devices of equipment to meet the capacity and specifications.
- rightarrow Avoid using multi-outlet if possible, and use the code lines as short as possible. .
- ☞ Used handles of tools and equipment used to repair electrical equipment that is made of a nonconductor.
- Some with a larger-capacity fuse than that of original one.
- Sectorical facilities such as outlets or switches are installed far away from water, chemicals, and oil.
- Solution when you repair the electrical equipment, stop the operation, power off the machine, and mark the "Repair in progress".
- ☞ Route the electrical cored or extension cord not through the aisle, hallway, and above the door.
- Since it is possible to be injured or get a shock because of bare wires and tool damage, pay attention when you make the electrical wiring.
- $\ensuremath{\bowtie}$ Heaters not used are kept off the switch by removing the plug.





5. Chemicals

Chemicals

- Some Must wear safety protective gear when handling chemicals.
- When purchasing or handling of chemicals, must aware of the nature and risks of the material through the Material Safety Data Sheet, MSDS.
- Pepending on the properties of chemicals, similar or low reactive chemicals kept together with each other during storage.
- When accident due to chemicals happens, wash the affected area for at least 20 minutes in running water, and it must be reported to the administrator.
- When you store drugs on the shelf, large-capacity drugs should be on the bottom of the shelf and take the physical action to prevent the drug conduction.
- ☞ Safe passage of the laboratory is kept clean at all times.
- \bowtie Do not leave or store chemicals on the laboratory floor surface.
- ☞ Never touch or sniff directly in the mouth hazardous substances such as reagents.
- ☞ Above the bench, just put reagents required, and keep only the minimum amount needed as possible.
- IP When using chemicals to obtain a separate container, must indicate a name clearly.





6. Fume Hood

Fume Hood

- ☞ Use a fume hood when taking harmful chemicals, dusts, gases, or volatile substances.
- $rac{1}{3}$ Fume hood doors are open with minimal (less than 1/3) during the experiment.
- ☞ Check the pressure using a differential pressure gauge and goods easy to be scattered such as toilet paper.
- $\ensuremath{\bowtie}$ Do not put the head and body into the hood.
- See Always clean and manage internal and glass doors of the hood.
- Prohibit storage of combustible materials except the chemicals required for the experiment
- If you use electricity in fume hood, electric outlet plug should be installed on the outside of the fume hood.
- Im When handling chemicals, always wear proper safety protective equipment (gloves, masks, goggles, protective clothing, etc.)
- ☞ Check the cooling water connected to the fume hood, water supply/drainage, gas valve and pipes frequently.





7. Waste disposal

Waste disposal

- Smocking and firearms are strictly prohibited in the chemical waste handling and storage places.
- Solution When collect wastes, collect separately and display by the waste acid, waste alkali, waste organic solvent, waste oil, etc.
- ☞ Waste containers should take measures such as closing the double cap to prevent leakage or odor of the waste.
- Before the liquid waste treatment, fully investigate the nature of the waste and then neutralize and pretreat such as injection of

small amount of drugs added, etc.

- ☞ Be careful to avoid waste container being damaged due to conduction and degradation.
- $\ensuremath{\bowtie}$ General waste and hazardous waste are discarded separately.
- Collected chemical waste containers should be stored in a well-ventilated storage area where can avoid direct sunlight. Do not neglect it in the places such as hallways, stairs, etc.





8. Gas

Gas

- Mark the type of gases on the gas cylinders and gas lines.
- Solution: Cylinders should be fixed on the wall or test benches by a chain or a belt to avoid conduction.
- ☞ During the transportation and storage of the containers, must put the cap on them.
- ☞ During the transportation of the containers, must transport them after chaining to the cart.
- ☞ Do not handle the flammable gases near chemicals or at the places where the spark-plug which generates fire and sparks exists.
- Frequently test the leakage of the flammable, toxic, valve threads of corrosive gases, safety devices, connection parts, etc.
- If you do not use the cylinder in long-term, must block the valve and emit all of the pressure in gas pipeline.
- Always wear a protective gear during operations such as pressure regulators, connecting or disconnecting the lines.
- Take an action immediately to get the gas supply company to retrieve the faulty containers and empty bottle.


★ Lab policies

9. Gas list

Process	Equipment	PN ₂	GN₂	He	Ar	02	CF ₄	CHF 3	SF ₆	C₂H₄	SiH ₄ 5%	SiH ₄ 100%	H ₂	NH ₃	BCL ₃	CL ₂	C ₄ F ₈	GeH₄	N ₂ O	CH₄	DCS	PH₃	HBr	비고
	Mask aligner	0																						
Photo	Nano Imprinter		0																					
PHOLO	Spin coater		0																					
	PR Wet station		0																					
	Dielectric RIE	0	0		0	0	0	0																
	Metal RIE	0	0		0	0			0						0	0								
	Deep RIE	0	0	0	0	0	0		0								0							
Etch	PR Strip		0		0	0	0																	
Etch	Dielectric ICP	0	0		0	0	0	0	0						0	0								
	Metal ICP	0	0		0	0	0		0						0	0							0	
	Metal ICP#2		0		0	0										0							0	
	Wet station		0																					
	Furnace(DRY)	0				0							0											
	Furnace(WET)	0				0																		
	PE CVD#1	0	0			0	0				0			0					0					
	PE CVD#2	0	0	0		0			0		0	0		0						0				
Thin film	RF Sputter	0	0		0	0																		
	DC Sputter	0	0		0	0																		
	Evaporator	0			0																			
	SAM Coater	0			0	0																		
	LP CVD	0	0									0		0							0	0		
	UHV-CVD	0			0					0	0		0					0						





- 1. Cleanroom Definition
- 2. Facility resources
- 3. Equipment
- 4. Lab policies
- 5. Wet station
- 6. Emergency measures
- 7. Equipment reservation





1. Chemical classification

	acid	alkali	solvent
Definition	To clean up material in an aqueous solution that the hydrogen ions (H +)	Material by ionizing in an aqueous solution that fisheries ions (OH-)	It refers to any object that is used to dissolve other materials
Character	 Sour South Varying the blue litmus paper red, Neutralizing with base to produce the salt Reacts with Fe, Zn and metal Sikkim generate hydrogen (corrosive) 	 Bitterness M Varying the bluish red litmus paper Produce a neutralizing acid and salts Greasy texture 	 Most flammable strength If the long-term vapor inhalation headache, dizziness occur, and strong volatility,
Purpose	- Acids and bases are used in processes etching, cleaning quartz products, PR		-Organic solvents are used in wafer fabrication processes, equip, cleaning removing photoresist & photosensitive
Chemical	- HCI, H_2SO_4 , HNO ₃ , HF, BOE, H_2O_2	- КОН, NH₄OH	- Acetone, IPA, Methanol, PR
Use container	- Quartz, Glass, Teflon - HF, BOE : Only Teflon	- Quartz, Glass	- Glass









2. Wet Bench

1.Protective gear

1 Apron

- **②** Glove
- **3 Eye protector**
- **④** Respiratory protector
- 3. Bottle level : let manager know level is over half





2. Pressure gauge

: make sure the hood is working well









3. How to take-off safety gloves







4. Wet station safety point!

Check list

- ① Aprons: Check torn parts
- ② PVC/safety gloves
- : Input the air and check holes
- ③ Face protector: goggles, face shield
- (4) Respiratory protector: gas mask



Personal protective equipment (PPE) - (Law the 14th)

- Treating gas hazardous
- Generate evaporation from liquid hazardous
- Other things from environmental sections
 - Treating indoor chemical hazardous
 - Treating acute toxicity
 - Treating eye or skin irritation of chemical hazardous

If you do not follow laws,

Operation of laboratory will be forbidden

Less than 3 year penal servitude or less than 50,000,000 won penalty





5. Wet station room safety rules -I

-	Safety rules	-
1	Those who use all the chemicals (organic solvents, acids / bases) and toxic gases should receive safety training from safety representative and should be fully aware and understand safety precautions.	
2	Be aware of the location of the First Aid Tool (emergency exits, fire extinguishers, oxygen masks, eyewash, etc.).	
3	All chemicals should be used within well-ventilated hood (Wet station), and do not wear contact lenses in the place to use chemicals.	
4	Put tools and supplies assigned place after use.	
5	You should separately store and dispose of organic solvent, alkali and acid.	
6	You should not mix acid and organic solvent because it can be cause explosive and severe accidents.	
7	All chemical containers should be able to distinguish by attaching the cover (for example, "acid", "alkali", "organic chemicals")	
8	Be carefully use, pour chemical in bath, and keep the closure of chemical container clean.	
9	Check the safety protector before you use it to handle chemical.	
10	Do not touch the unknown liquid. You can check the pH of chemical by test paper. Then inform staff about situation.	





5. Wet station room safety rules -II

-	Safety rules	-
11	Do not use unapproved chemicals before consultation with Managers in the clean room.	
12	Use chemicals in assigned bath as properties of chemical. (acid, alkali, organic solvent)	
13	If you use heater, do not heat up beyond the proper temperature, you should not leave the place until the end of the process.	
14	You can store individual laboratory instruments in assigned locker, after using the Wet- station, you should keep wet station clean for next users.	
15	Open the new chemical after running used chemical out.	
16	Put an empty chemical bottle in storage as properties of chemical.	
17	You can dispose waste chemical in assigned container (20 ℓ Bottle) after level check of 20 ℓ Bottle, and if it more than $1/2$ level. Inform to the administrator.	





- 1. Cleanroom Definition
- 2. Facility resources
- 3. Equipment
- 4. Lab policies
- 5. Wet station
- 6. Emergency measures
- 7. Equipment reservation



***** How to Respond in Emergencies

1. Medical Emergency Response

Contents	Respond	-
If you get any chemicals on the skin	 Undress chemicals contaminated clothing. Wash affected part for at least 15 minutes under running water. The first 20 minutes washing is very important because that washing step neutralize and dilute water and chemicals. (Continue to wash in flowing water for a long time is better.) Seek medical attention. 	
In the case that you get the chemicals in the eye	 Wash eyes for more than 15 minutes from the eyewash. Holding the eyelids and turning pupil to enter the water evenly to eyes Seek medical attention as soon as possible. * Install washing device near the workbench dealing with chemicals or ventilation device so that you can wash the eye quickly. 	
If swallowed chemicals	 Follow first aid measures indicated to display bottles of chemicals. If first aid measures are not listed, drink sufficiently large amounts of water to dilute acid or alkaline in the body. If safety accident occurs, do not panic, stay calm, and take a first aid quickly and appropriately. (contact 119 rescue team directly) Never put finger to mouth to spit chemicals by vomiting by force. (to prevent secondary damage of esophagus and airway) 	



How to Respond in Emergencies





***** How to Respond in Emergencies

2. Emergency exits and shower







***** How to Respond in Emergencies

3. Fire extinguisher and Hydrant

📕 Fire extinguisher 🔳 Fire Hydrant



Entrance parking lot



How to Respond in Emergencies

4. Fire extinguisher operating method and characteristic



- 1. Move to fire spot
- 2. Remove safety pin



3. Stand with the wind



4. Aim nozzle to fire and grab lever.

- 1) Response procedure
 - 1 Move to fire spot
 - ② Remove safety pin
 - 3 Stand with the wind
 - 4 Aim nozzle to fire and grab lever.
- 2) Extinguisher character inside CR
 - CO2 fire extinguisher
 - 1 Get rid of oxygen around the fire place
 - 2 Advantage that there is no debris
 - $\ensuremath{(3)}$ A large amount of oxygen is required



***** How to Respond in Emergencies

7. Protective device



Emergency Box(1)

Air mask Portable lamp Protective suit Dust mask



Emergency Box(2)

Protective suit Mask for fire evacuation Portable lamp



Protective box

Protective suit Fireproof gloves fireproof blanket Eye protector earplug





HF cream disinfectant, a Band-Aid Wrist guards Portable oxygen, etc.



How to Respond in Emergencies







- 1. Cleanroom Definition
- 2. Facility resources
- 3. Equipment
- 4. Lab policies
- 5. Wet station
- 6. Emergency measures
- 7. Equipment reservation



1. Sign up and apply for self user (ucrf.unist.ac.kr)

UNIST member		Industry member	Extern	al member							
ID/E-mail	m*	k*m @unist	.ac.kr								
Password	*	*****		Confirm							
Name	К	il dong									
Department		UCRF									
Student ID No. / Professor ID No. / Staff ID No.		20*39									
Contact	Extension	4064									
	Cell phone	010 *	*** -	****							
Principal Investigator	Pr Select	rof. Kim		Professor Search							

Click sign up-> select UNIST Member -> input Portal id/pw & click confirm -> personal info displayed automatically -> input prof.'s name & clcik search -> find your prof. and click -> click Create Account

Nano Fabrication Center	\sim
Etching	~
Deep Si Etcher	\sim

My page -> click request for self-user in left bottom corner -> pop up above manu, select machine and click Apply After approval can reserve in the UCRF homepage and Portal Equipment research



2. Access permission application

0 새로수가 ∥ 100지원의 Nginx	Access Permis	sions Application $rac{1}{2}$ > Participation Space > Access Permissions Application
Wetcome 2B31 LOCOT My Page Edit profile Edit LITIIST Central Research Facilities About UCRF Equipment Status Data Room Participation Space 2	UNFC Entrance	Application VNFC Entrance Application
Equipment Search Please enter the name of equipment. Laboratory Education & Seminary OCI Tour Application	Advisor	
Access Fernicences Application	Department	연구지원본부행정실
Equipment Reservation (Analysis Reservation (Analysis) Reservation (Analysis Reservation (Analysis) Reservation (Analysis) Reserv	Applicant	김민재
Request 27 28 29 30 31 1 2 3 4 5 6 0 8 9 10 11 10 11 10 13 14 15 16	Contact	Office Select 🔹 -
Download of document Status of Education 17 18 19 20 21 22 23 Download of document Status of Education 24 25 26 27 28 29 30 Education 600 MHz FF-NMR > 31 1 2 3 4 5 6		Cell phone • 4848 - 2951
Notice Archive	Position	직원
Thermal Analysis Notice 2016.01.22 Proceedings of the procedure is different by each lise the procedure is different by each l	E-mail	mjkim @ unist.ac.kr Select \$
Normal TEM will be repaired 2016.01.20 Normal XED is working with manual mode only. 2016.01.18 No entry normal TEM room on 1/15 2016.01.14 No entry normal	Date (Period)	 ○ 1 day (5,000won) ○ 1 month (90,000won) ○ 3 month (180,000won)
BE L 2 - 2 (2014) 2 2 1 2 3 (Renamed the BE L 2016.01.1.2) This is the orter of discount for the use of equipment. Please refer to the specified orteria of discount.	(renou)	O 6 month (320,000won) daily and 1/3/6months possible make sure the begin date
go to UCRF homepage	fill in the	form and click apply



3. Reservation-I

Portal -> Research equipment -> Reservation/input result -> Apply

UNIST	Administration Room MINJAE KIM Switch Position Settings Site map Log out Q KOR ENG	
Home Human Resou	rce Financial Procurement Asset Budget Research Equipment Fund Intellectual Property Application for use of lectur	
Approval for Equipment Fee	Equipment Reservation	
Detailed Navigation	☐ Equipment reservation	p
Equipment Reservation	Search condition	
Equipment Reservation List		
Equipment Status	Researvation date: 2015.08.01 😰 ~ 2016.02.17 😰 © Reservation O Input result O Completed O All	
Favorite 🌣	1st classification: Image: Classification: Equipment name:	
	Equipment booking list	
	Application cancel	
	Select Status Sortation Equipment name Chief of research Researvation date Reservation time Fee 1st classification 2nd classification name Application date Free_Test Free_Longterm Mem	0
	□ Reservation Self PR Asher 2016.02.02 16:00~17:00 0.00 UNFC - 나노소자공정실 Etching 2016.02.02 16:11 □	

* You can check Self/request history and input memo



3. Reservation-II

"application" click(previous screen), below menu will pop up -> 1st/2nd/3rd category equipment select -> time select -> "application" click

elect equipr	ment														1
/lember ID:	mjkim@uni	stac.kr		20139 /	Kil d	ong			Suk	scriber	20139	Kil d	long		
Lst classification	n: UNFC - 나노	⊏소자공정실		▼ 2nc	d classificatio	n: Etching			▼ 3nc	l classificatio	n: PR Asher				
roject infor	maion														
Chief 100	Chief	Kim		Detail	project num	ber		de	etailed item		Executable a	mount		Useable a	amount
100	J	NIM			- 147 - 789 		-			-		0		0	0
eservation (control info	rmation													
									100	-	1.1.1	1	-		1
Reservation ti 1.0 시간	me unit		aily maximum	reservation	time			on open timir	ng		elable timing	9	Fee 1.0 OP	20.000 BI	
유의사항02	실적입력시 진혁 After using the	행횟수를 정확		(Input result s	should NOT	be time or sa	14 일전 ample amount	but be oper	ation number)	1시	간전		10 00	20,000 원	
유의사항02 유의사항01 /	After using the	행횟수를 정확 e machiine, Pe	이 입력하세요) ower "OFF"	1			ample amount					02/13(S)			02/16
유의사항02 · 유의사항01 / Time/Date		행횟수를 정확	이 입력하세요((Input result s	should NOT	02/07(S)		but be oper-	ation number) 02/10(W)		산전 02/12(F) □	02/13(S)	02/14(S)	02/15(M)	02/16
유의사항02 (유의사항01 / Time/Date 00:00~01:00	After using the 02/02(T)	행횟수를 정확 • machiine, Po 02/03(W)	이 입력하세요) ower "OFF" 02/04(T)	02/05(F)	02/06(S)	02/07(S)	ample amount 02/08(M)	02/09(T)	02/10(W)	02/11(T)	02/12(F)		02/14(S)	02/15(M)	10.0
유의사항02 1 유의사항01 / Time/Date 00:00~01:00 01:00~02:00	After using the	행횟수를 정확 e machiine, Pe 02/03(W)	이 입력하세요(ower "OFF" 02/04(T)	02/05(F)	02/06(S)	02/07(S)	02/08(M)	02/09(T)	02/10(W)	02/11(T)	02/12(F)		02/14(S)	02/15(M)	
유의사항이2 / 유의사항이1 / Time/Date 00:00~01:00 01:00~02:00 02:00~03:00	After using the	행횟수를 정확 machiine, P4 02/03(W)	이 입력하세요) ower "OFF" 02/04(T)	02/05(F)	02/06(S)	02/07(S)	02/08(M)	02/09(T)	02/10(W)	02/11(T)	02/12(F)		02/14(S)	02/15(M)	
유의사항02 1 유의사항01 / Time/Date 00:00~01:00 01:00~02:00 02:00~03:00 03:00~04:00	After using the	행횟수를 정확 e machiine, P4 02/03(W)	이 입력하세요(power "OFF" 02/04(T) 	02/05(F)	02/06(S)	02/07(S)	02/08(M)	02/09(T)	02/10(W)	02/11(T)	02/12(F)		02/14(S)	02/15(M)	
유의사항이2 위 유의사항이1 / Time/Date 00:00~01:00 0 01:00~02:00 0 02:00~03:00 0 03:00~04:00 0 04:00~05:00 0	After using the	행횟수를 정확 e machiine, Pi 02/03(W)	이 일력하세요/ power "OFF" 02/04(T) 	02/05(F)	02/06(S)	02/07(S)	02/08(M)	02/09(T)	02/10(W)	02/11(T)	02/12(F)		02/14(5)	02/15(M)	
유의사항이 / / / / / / / / / / / / / / / / / / /	After using the 02/02(T)	행 수를 정확 e machline, Pr 02/03(W) 	이 입력하세요(ower "OFF" 02/04(T) 		02/06(S)	02/07(5)	02/08(M)	02/09(T)		02/11(T)	02/12(F)		02/14(5)	02/15(M) 	
유의사항이2 위 유의사항이1 / Time/Date 00:00~01:00 0 01:00~02:00 0 02:00~03:00 0 03:00~04:00 0 04:00~05:00 0 05:00~06:00 0 06:00~07:00 0	After using the 02/02(T) 02/02	명횟수를 정확 e machine, Pr 02/03(W) 	이 입력하세요. ower "OFF" 02/04(T) 	02/05(F)	02/06(S)	02/07(S)	02/08(M)	02/09(T)	02/10(W)		02/12(F)			02/15(M)	
유의사항이2 위 유의사항이1 / Time/Date / 00:00~01:00 / 01:00~02:00 / 02:00~03:00 / 03:00~04:00 / 04:00~05:00 / 05:00~06:00 / 06:00~07:00 / 07:00~08:00 /	After using the 02/02(T) 02/02(T) 02/0	범 횟수를 정확 e machine, Pr 02/03(W) 	이 입력하세요. ower "OFF" 02/04(T) 	02/05(F)		02/07(S)	02/08(M)	02/09(T)	02/10(W)		02/12(F)			02/15(M)	
유의사항이2 유 유의사항이1 / Time/Date / 00:00~01:00 / 01:00~02:00 / 02:00~03:00 / 03:00~04:00 / 04:00~05:00 / 05:00~06:00 / 06:00~07:00 / 07:00~08:00 / 08:00~09:00 /	After using the 02/02(T) 02 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	병횟수를 정확 e machiine, Pr 02/03(W) 	이 일력하세요) ower "OFF" 02/04(T) 				02/08(M)	02/09(T)	02/10(W)		02/12(F)			02/15(M)	
유의사항02 유의사항01 /	After using the 02/02(T) 02/02(T) 02/02(T) 0 0 0 0 0 0 0 0 0 0 0 0 0	병횟수를 정확 e machiine, Pr 02/03(W) 	이 입력하세요/ ower "OFF" 02/04(T) 				02/08(M)	02/09(T)	02/10(W)		02/12(F)			02/15(M)	

Equipment list only you have self user qualification will be displayed.



4. Input result

Equipment reservation						(😡 help
Search condition							
Inquiry Researvation date: 2015.08.01 1st classification: v Intervention Intervention		Equipment name:					
Equipment booking list							
Application 📑 Reservation cancel 📝 Input result	k row which you want, and click i	nput result					
Celect Status Sortation Equipment name Chief of research	Researvation date Reservation time Fee	e 1st classification	2nd classification name	Application date	Free_Test	Free_Longterm	Memo
Reservation Self <u>PR Asher</u>	2016.02.02 16:00~17:00 0.00	인 UNFC - 나노소자공정실	Etching	2016.02.02 16:11			6

Save																
Reservation infor	mation															
Reservation number: Application date:	2016004867 2016.02.02		Reservation date: Reservation time:			Client author Rate	uzation.	Self	: Equipment r	1	mjkim@u PR Asher	nist.ac.kr		Kil dong		
Project informaio	n															
Chief of research	Chi	Kim	De	etail project numb	er			detailed item		Execut	table amo	ount 0	0	Useable amount		
Fee									•			•	0		2	input result
Cost				Unit quant	ity Ur	nit unit amo	unt	discount applying	Option app	lying	Amount	Fee	Rate	Amount		
기본공정료					1.0 OF	P	20,000	~			1.0	20,0	00 50	10,0	000	
합계												20,0	00	10,0	00	
Process conditior	1														3	process conditio
Power(W)				Pressure(mT)					Process Time	e(sec)						
CF4(sccm)				O2(sccm)					Ar(sccm)							
Remark																





Application for chemical import

<u> 화공약품 반입신청서 (나노소자공정실)</u>

반입일자	(날짜)			
반출일자(예정)	(날짜)			
신경인	소속	이름	이메일	지도교수
	순번	1	2	3
	화학약품명			
	분류 (준/열기/유기)			
화학약품	수량			
	용량			
	유효기간			
1. MSDS에 근거하여 상기 자료를 각성하고, 제조사의 MSDS 반드시 제출 2. 분류 - 산, 엽기, 유기 (폐기 - 불산, 황산, 기타산, 엽기, PR 등) 참고사항 4. 화학약품 유효기간 확인 필요 4. 화학약품 등에 아래의 정보(화학약품명, 신청인) 태그 부착하여 관리 5. 보관기간 (1년 - 감장제/유기, 6월-산, 알랑리)				
본인은 음산과학기술원 연구지원본부 나노소자공정실의 안전 편리 규정을 준수합니다. 또한 위 내용에 대한 내용이 정확함을 확인하고 잘못된 정보, 폐액 분류 규정을 지키지 않아서 발생하는 사고에 대하여 연대 책임 질 것에 동의합니다.				
		-	청 인: 도교수:	(서명) (서명)

Chemical	Ex. Acetone		
Import (Date)	Ex. 21. 01. 01		
Export (Date)	Ex. 22. 12. 31		
Property	Solvent		
Department	UNIST UCRF		
Name	Kang O Kim		
Contact No.	010, ****, **** (#4182)		

Chemical	
Import (Date)	
Export (Date)	
Property	
Department	
Name	
Contact No.	

Ex)

Chemical	Acetone	
Date import		
Date export		
Chemical Property	Solvent, Acid, Alkali	
Department	UCRF	
Name	ХХХ	
Contact No.	010-****-****(#4165)	

Max PR 1 year, other chemical 6months can stock.

Chemical	
Date import	
Date export	
Chemical Property	
Department	
Name	
Contact No.	



🔆 Appendix #2

Holiday safety checklist for the UNFC

연구지원본부 나노소자공정실(클린룸) 휴일 점검 일지

			연구활등종사자		
긴물(호실)	실험실명	점감 열자	소속(학부)	점검자	책업자
자연과학관(B101)	나누소자공정실	2021		(인)	(인)

★ 🗆 체닷컴 안 내용한 졌상훈 담당자에게 제출비합니다.(🗋 의 내용은 휴업전 담당자 전콤 진행) 🌱 점고 : 중상(0), 약상(X), 수락(△)

	향 믁	비고 확	언 <u>틁 에</u> 사 향
	실험실의 정리정돈 및 청결상태	옥안점검	
[연구실내 금연, 음식물 반입 및 섭취여부	옥안점검	
열반안전	비상 연락망 및 비상시 행동요령 비치 상태	옥안점검	
	실험 폐기물 관리상태	옥안점검	
[위험표지 및 안전, 경고 표지 부착 역부	옥안점검	
	화재별 소화기 적정 비치 및 숙지 역부	옥안점검	
소방안전	화재경보기의 설치 및 설치장소 숙지역부	옥안점검	
	불꽃 내는 난방기구/실험기기 관리 상태	옥안점검	
	23업 盟퍼 등작 상태	통작전검	
Smock room	자동문 동작 상태	통작점검	
	Air shower 등작 상태	통작전검	
	장비 alarm 및 이상 여부	통작전검	
White room	누수 및 Gas detector alarm 역부	옥안전검	
Dia ta cara da	Air shower 등작 상태	통작전검	
Photo room	장비 alarm 및 이상 여부	옥안점검	
	물질안전 보건자료(MSDS)의 비치 여부	옥안점검	
	약품별 저장용기 및 보관 장소 적정 여부	옥안점검	-
	약품 위험성 분류에 따라 분류 보관 여부	옥안점검	
	高亮后, 배기 등 환기시설 관리 및 작동 상태	통작전검	-
Wet room	폐앩룼 레벨 상태(W2.황산)	옥안전경	_
(최공안전)	<u>폤앩룴</u> 레벨 상태(W3.알칼리)	옥안점검	
(1022)	폐앩룼 레벨 상태(W4.불산)	옥안점검	
	폐앩룼 레벨 상태(W4.황산)	옥안전검	-
	폐액, 레벨 상태(W5.불산)	옥안점검	
	개인 보호 장비 보유 및 사용 상태	옥안점검	
	전기기기의 절연, 피복손상 및 접지 적정역부	옥안점검	
D	코드, 배선기구의 용량 및 규격 적합 여부	옥안점검	
전기안전	전열기 주변 가연성물질 등의 방치 여부	옥안점검	-
	누전차단기의 설치 및 작동상태	통작전검	—
	고온/고압 실험장비 산용신 안전장치 설치상태	통작점검	
7777	레이저 등의 광학기구 작동상태	동작전경	
	Gas, water, oil leak 역부	옥안점검	
ł	Burn scrubber 등작 상태	동작점검	
	Power drain 등작 상태	동작점검	—
신부명	Pump류 소음(알람) 및 oil leak유무	옥안점검	—
	폐수 탱크 이상 유문	옥안점검	—
	폐수 처리 장치 등작 상태	통작점검	\neg
	갔슈케뷔넷 알람 역부(있상심 케뷔넷 #기재)	동작점검	
ł	산소 농도 측정기 등작 상태(정상범위 20.9%)	18-29.5	\neg
가스안전	Burn scrubber 등작 상태 및 누수 여부	통작점검	\neg
(Gas room)	가스용기 고정 및 관리(별브 및 배관) 상태	옥안전경	\neg
	미사용 고압가스용기 보호캡 설치여부	옥안전경	
			1

※ 이상 발생시 점검 열자 및 이상 내용을 득이사항에 펼쳐 가세할 것!



***** Appendix #3

Rules for using UNFC

Rules for using UNIST Nano Fabrication Center (UNFC).

(UNFC. June 4. 2021).

Article 1. Access

- ① The UNFC is open 24 hours a day. Only research workers who have completed safety training and passed the assessment can enter the UNFC...
- ② A person can apply for 1 day or 1 to 6 months access on the UCRF website and can enter (exit) using his or her pass after approval by the person in charge. The entrance fee is charged according to the access period, and it is non-refundable...
- ③ Each user must enter (exit) individually using the pass card with their own identity. It is prohibited to enter using another person's pass or to enter together without permission.
- ④ A person who uses the UNFC at night (PM18-AM09 on the next day) or on holidays must enter after establishing personal safety and protection rules (accompanying 2 or more people, preparing for an emergency contact, etc.) for lab accidents...
- ⑤ A person who violates Article 1 section 1-4 stated above regarding to accessing UNFC shall be obligated to compensate for all safety and property damage caused by the violation...

Article 2. Use of Space

a)

- ① Only a person who has experience at UNFC for more than 6 months can use the equipment at night, on weekends, and on holidays...
- ② A UMCL user on weekends or holidays must fill out the UNFC holiday safety sheet (Attachment 2) provided in each laboratory room, and submit it to equipment manager, with the signature of the professor (or supervisor) within 3 days from the date of use...
- ③ A UNFC user must understand and follow the general safety rules for the cleanroom...

1) In the cleanroom, entering with make-up and smoking is prohibited. The room must be kept quiet, and tidy up at all times...

2) A user of the cleanroom must comply with the following...

A. To maintain the "clean class", only authorized items (non-dusting paper, coated paper, etc.) should be used. (Prohibited from pencil, water-based pen, etc.).

B. Only items (parts, equipment, etc.) approved by the equipment manager can be brought in after cleaning...

C. Prohibited from sitting on a workbench, leaning on equipment, running, or sitting on the floor...

4) A user must wear appropriate safety protection before the experiment. $\!$

5) A user must check that there is no problem before using equipment, chemicals, etc., and if there is a problem, a user should promptly report to the equipment manager...

6) A user must thoroughly fill out the "Performance Records" after using the equipment.

7) UNFC holiday safety sheet must be submitted to the cleanroom person in charge after obtaining the approval of the principal investigator of the user.

8) A user must take safety measures by posting the contents of the experiment to deliver accurate information to others if he inevitably leaves his seat during the experiment.

9) A final user must leave the cleanroom after tidying up the area and checking up for any problem in the cleanroom.

- ④ A user must wear the blue dust-proof clothes (not allowed personal items) provided in the smock room, follow the order of wearing. A user must not wear or soil another person's clothes and tidy up when undressing...
- ⑤ A user should clean up the area after finishing the experiment and must promptly notify the equipment manager if there is a problem with the equipment or environment. Violation of the notification obligation may result in restrictions on the use of the equipment...



Appendix #3 Rules for using UNFC

Article 3. Use of Equipment

(1) A person who wishes to use the equipment of UNFC must reserve and

use the equipment after completing the training of the equipment manager, assessment test, and acquiring self-user qualification. (Analysis or process request is irrelevant to equipment training and qualification test.).

- ③ A user who completes regular or occasional training (including practice) by the equipment manager can receive practical training from the senior student of his or her laboratory to improve proficiency before the assessment test. The qualification of the senior must be at least 1 year of experience (more than 5 times in the previous 3 months) in using the equipment. The laboratory (in the case of an outsider, affiliated institution) is responsible for all safety and property issues arising from the practical training conducted by the senior student...
- ③ If there is no record of equipment used in the last 90 days, the qualification for self-use ends. A person who wants to reacquire the self-user qualification must receive equipment training and pass the assessment test conducted by the equipment manager...
 - ④ Equipment reservations or requests can be made on the UNIST Portal System and the website of UCRF (http://ucrf.unist.ac.kr), and the reservation time should not be unnecessarily occupied for a long time, so it does not affect the opportunity for others...
 - ⑤ Bringing chemicals and other items for personal use should be consulted with the equipment manager. After submitting an application form for importing chemical and material safety data sheets (MSDS), they can be brought in with the approval of the equipment manager. (refer to attachment 1).
- (6) A user must notify the equipment manager of any special matters before and after using the equipment...

Article 4. Cancellation after equipment reservation.

a)

 A self-user can cancel equipment reservation by himself up to 2 hours before equipment reservation time. However, E-Beam lithography can be canceled up to 24 hours before. (% Cancellation is not possible after the cancellation deadline has passed.)

② In the case of a process request, a user who does not appear at the reservation time without prior notice to the equipment manager will be charged a processing fee for the reserved time after the process reservation.

Article 5. Laboratory safety and user management.

- A person who harms the safety of the laboratory or violates the rules of using UNFC and damages the equipment use of another person can be subject to penalties according to [Attached Table 1] and be taken appropriate action.⁴
- ② If the violation of the rules is deliberately determined, the sanctions may be strengthened. If a user voluntarily declares after violating the rules, the sanctions may be eased.
- ③ If it is judged that the sanctions are difficult to be properly implemented due to the status of the violator (graduation or resignation), the user may be blocked from accessing UNFC...
- ④ A person who damages the property and facilities of UNFC by violating the rules shall be held liable to compensate for the damage.
- (5) If a violator does not follow the sanctions, the advisor of the violator will be held jointly responsible. (In the case of an outsider, the supervisor in charge of the affiliated institution).



Thank you

